



### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	Ι <sub>D</sub> T <sub>A</sub> = +25°C
-30V	95mΩ @ V <sub>GS</sub> = -10V	-2.8A
-30 V	140mΩ @ $V_{GS}$ = -4.5V	-2.3A

### Description

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### Applications

- Backlighting
- **DC-DC Converters**
- **Power Management Functions**

### **DUAL P-CHANNEL ENHANCEMENT MODE MOSFET**

## **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

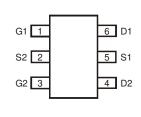
### **Mechanical Data**

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 3
- Weight: 0.013 grams (Approximate)

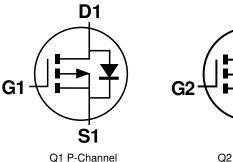


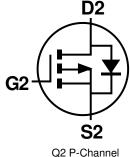
TSOT26

Top View



Top View





# **Ordering Information** (Note 4)

	Part Number	Case	Packaging					
	DMP3164LVT-7	TSOT26	3,000 / Tape & Reel					
	DMP3164LVT-13	TSOT26	10,000 / Tape & Reel					
Notes:	Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (BoHS). 2011/65/EU (BoHS 2) & 2015/863/EU (BoHS 3) compliant.							

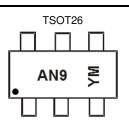
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# Marking Information



AN9 = Product Type Marking Code YM = Date Code Marking  $\overline{Y}$  = Year (ex: G = 2019) M = Month (ex: 9 = September)

Data Coda Kay

Dale Coue Key												
Year	201	9	2020		2021	20	22	2023		2024	2	2025
Code	G		Н				J	K		L		М
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	-30	V
Gate-Source Voltage	V <sub>GSS</sub>	±12	V
Continuous Drain Current (Note 6) $V_{GS}$ = -4.5V	ID	-2.8 -2.2	А
Maximum Continuous Body Diode Forward Current (Note	ls	-1.0	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	-16	А

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	0.83	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 5)	R <sub>0JA</sub>	151	°C/W
Power Dissipation (Note 6)	PD	1.16	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 6)	R <sub>0JA</sub>	108	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

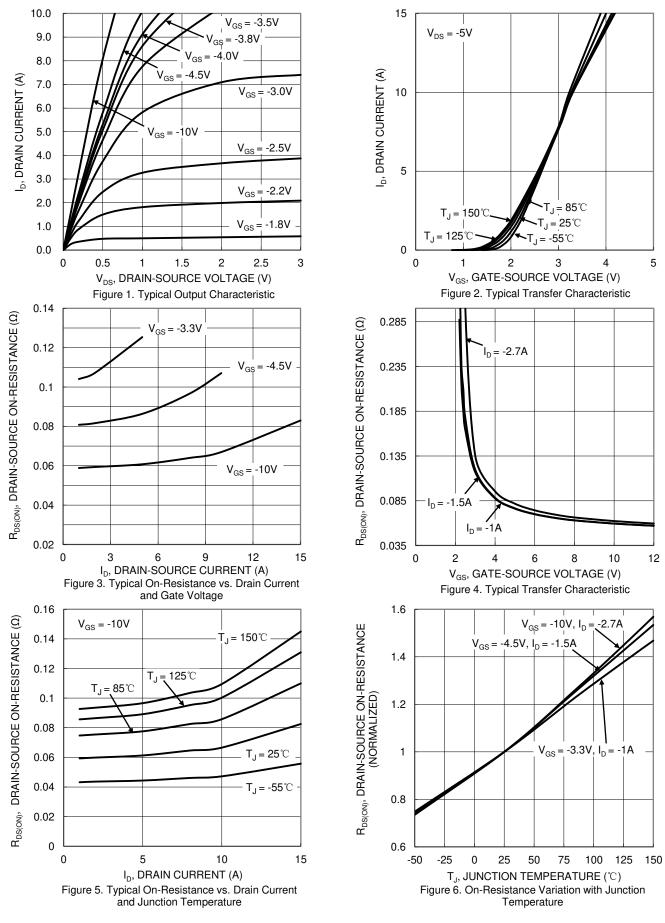
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	Symbol	IVIIII	тур	Wax	Unit	Test condition	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30	_	1	V	$V_{GS} = 0V, I_D = -250\mu A$	
				-1.0			
Zero Gate Voltage Drain Current	IDSS	_		-	μA	$V_{DS} = -24V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_		±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)				r		1	
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.7	-1.1	-2.1	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
			60	95		$V_{GS} = -10V, I_D = -2.7A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	81	140	mΩ	$V_{GS} = -4.5V, I_D = -1.5A$	
			104	300		$V_{GS} = -3.3V, I_D = -1A$	
Diode Forward Voltage	V <sub>SD</sub>		-0.8	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 8)						• • •	
Input Capacitance	Ciss	_	324	—			
Output Capacitance	Coss		44	_	pF	$V_{DS} = -15V$ , $V_{GS} = 0V$ , f = 1.2MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>		33	—			
Gate Resistance	Rq		7.2	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qq		4.4	—		$V_{DS} = -15V, V_{GS} = -4.5V, I_D = -3A$	
Total Gate Charge (V <sub>GS</sub> = -10V)	Qa		8.6	—			
Gate-Source Charge	Q <sub>qs</sub>		0.3	—	nC	$V_{DS} = -15V, V_{GS} = -10V, I_{D} = -3A$	
Gate-Drain Charge	Q <sub>ad</sub>		1.5	—			
Turn-On Delay Time	t <sub>D(ON)</sub>		7.7	_	1		
Turn-On Rise Time	t <sub>R</sub>		17.8	_	1	$V_{GS} = -10V, V_{DS} = -15V,$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>		17.8	_	ns	$R_G = 6\Omega, R_L = 15\Omega$	
Turn-Off Fall Time	tF	_	29.5	—	]		

Notes:

Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.

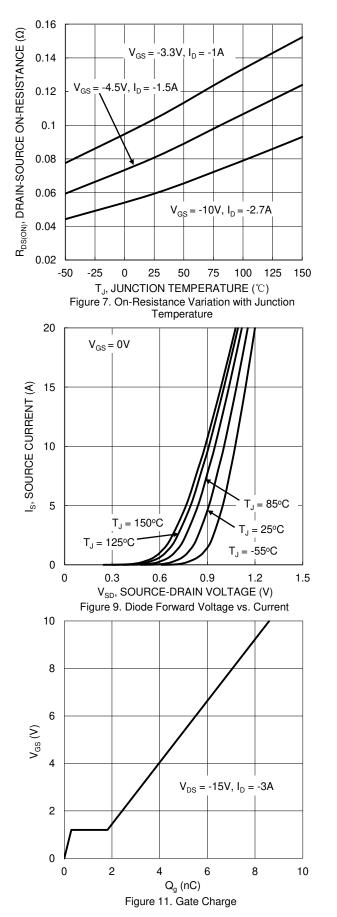


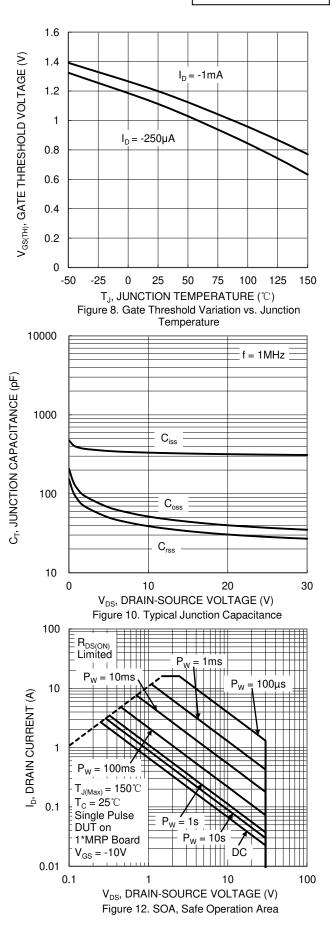
### DMP3164LVT



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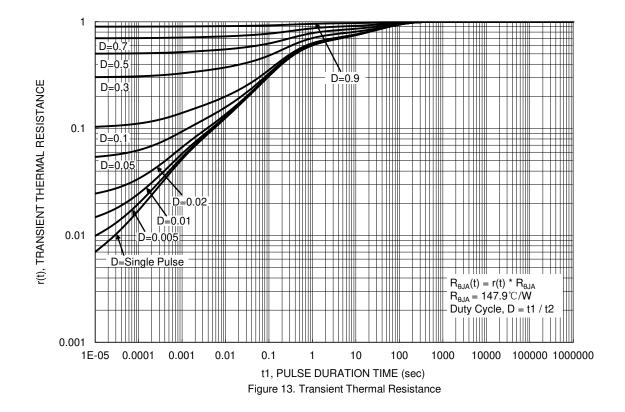






DMP3164LVT Document number: DS41715 Rev. 2 - 2



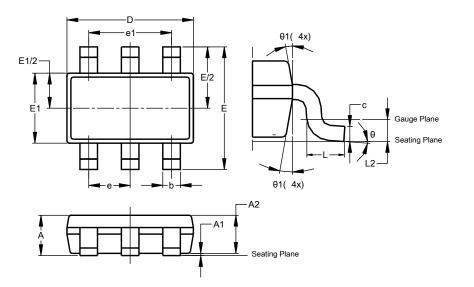




### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

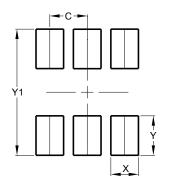
TSOT26



TSOT26									
Dim	Min Max Typ								
Α	-	1.00	-						
A1	0.010	0.100	-						
A2	0.840	0.900	-						
D	2.800	3.000	2.900						
Е	2	.800 BS	С						
E1	1.500	1.600							
b	0.300	0.450	-						
С	0.120	0.200	-						
е	0	0.950 BSC							
e1	1	.900 BS	С						
L	0.30	0.50	-						
L2	0	.250 BS	С						
θ	0°	0° 8° 4°							
θ1	4°	12°	-						
A	II Dimen	All Dimensions in mm							

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



TSOT26

Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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